Optronics Systems

DUAL WAVEBAND INFRARED DETECTOR

The company designs, develops and manufactures Infrared (IR) detectors at its dedicated facility in Southampton, UK. With a reputation for providing customers with the best in high performance and cost-effective technology for IR camera systems, we offer a unique level of expertise.

The Condor II Dual Waveband Infrared (DWIR) detector is a 640 x 512 Mercury Cadmium Telluride (MCT), Integrated Detector Cooler Assembly (IDCA), designed for high performance imaging in the 3 - 5µm Medium Wave Infrared (MWIR) and 8 - 10µm Long Wave Infrared (LWIR) wavebands.

Each of the 640 x 512 pixels in the array can be switched between MWIR and LWIR sensitivity mode by changing the bias voltage on the device, ensuring spatial coherence between the two bands.

By integrating the photocurrent from each band in separate storage cells at the pixel, both bands can be captured and output within a single frame period, optimising the temporal coherence between bands.

The entire storage capacity for each pixel can also be dedicated to either of the MWIR or LWIR bands, thus providing user selectable and interchangeable high performance MWIR, LWIR or DWIR operation.

Using the MCT process, the Condor II DWIR detector provides the highest environmental integrity along with the superior performance of focal plane detectors.
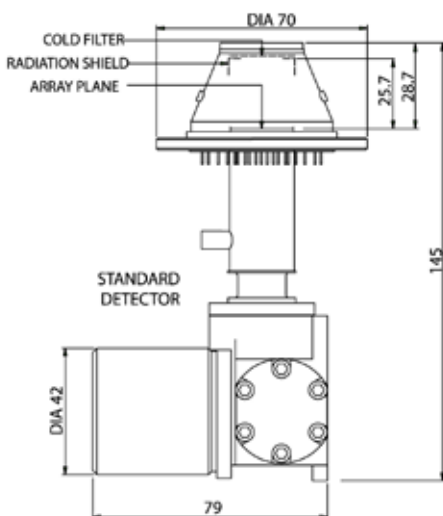
CONDOR II

MAIN FEATURES

- Snapshot or interlaced operation
- Simple to use
- Concurrent 3 - 5μm and 8 - 10μm operation
- Dedicated 3 - 5μm operation
- Dedicated 8 - 10μm operation
- High electro-optic performance with low crosstalk, automatic anti-blooming at the pixel level and excellent sensitivity
- Windowing gives enhanced frame rates over selected areas of the array
- Single sensor solution for Medium Wave (MW) and Long Wave (LW) without compromise
- Combination of wave bands provides improved DRI over 1st & 2nd Generation
- Wave band switching to optimise performance in all imaging conditions.
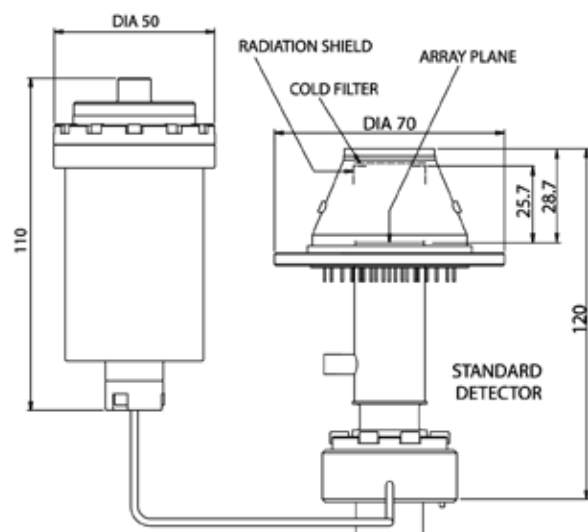
Key Benefits
- Low cost
- High resolution
- High frame rate
- High sensitivity
- Reduction in false alarm detection.

TECHNICAL SPECIFICATION

FORMAT	
Array	640 x 512 pixels
Pixel Pitch	24um
Active Area	15.36 x 12.29mm
TYPICAL PERFORMANCE	
NETD (median) LW	28mK (22mk dedicated LW)
NETD (median) MW	28mK (11mk dedicated MW)
Pixel Operability	>99%
INTERFACE PARAMETERS	
Modes	Snapshot or interlaced
Configuration Control	Single serial interface
Output Voltage Range	2.8V
Charge Capacity (dedicated)	LW 8 x 106 electrons
	MW 8 x 106 electrons
Number of Outputs	8
Pixel Rate	Up to 10MHz per output
Intrinsic MUX noise	50uV rms max
Array Operating Temperature	80K nominal
Nominal Operating Voltage	6V
Minimum Pins for Operation	26
Number of Input Clocks	1
Window Material	Germanium
Window Thickness	1.73mm
Cold Filter Material	Silicon
Cold Filter Thickness	0.4mm
ICDA	
Weight	<750g
Power Consumption	<10W steady state
Cooling Engine	Rotary Stirling engine
Operating Temperature Range	-40°C to +70°C
LINEAR ENGINE VARIANT	
Weight	950g
Power Consumption	<15W steady state
Cooling Engine	Linear Stirling engine
Operating Temperature Range	-40°C to +70°C

IDCA

Linear Engine Variant

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